

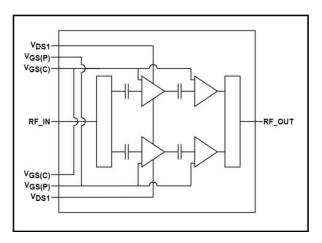
Product datasheet

Description

The H9G1822M60P is a LDMOS MMIC Integrated Asymmetrical Doherty based on 2-Stage with 60W saturated output power covering frequency range from 1.8 - 2.2 GHz.

The amplifier is 50 Ω Input matched with integrated input divider and output combiner into a small compact footprint which makes it ideal for integration.

Block Diagram



H9G1822M60P Block Diagram

Applications

- 3GPP 5G NR FR1 n1/34/39/65/66/70 and 4G-LTE B1/2/3/4/34/37/39/65/66/70
- Power Amplifier for Small Cells
- Driver Amplifier for Micro and Macro Base Stations
- Active Antenna Array for 5G mMIMO
- Repeaters/DAS
- Mobile Infrastructure







Over Molded Plastic Package 8 pin

Features

• Operating Frequency Range: 1.8 - 2.2 GHz

Operating Drain Voltage: +28VSaturation Output Power: 60W

Power Average: 3.15W50 Ω Input matched

Integrated Input Divider

• Integrated Output Combiner

Integrated Asymmetrical Doherty Final Stage

High Efficiency: 30%@2.19GHz, WCDMA

High Gain: 28dB@2.19GHz, WCDMA

• Small footprint: OMP400-8, 10.3x10.3mm

Ordering Information

| Part Number | Description |
|----------------|-------------------|
| H9G1822M60P | Reel Package |
| H9G1822M60PEVB | 1.8 - 2.2 GHz EVB |



Typical Performance

60W, 1.8 - 2.2 GHz LDMOS MMIC Amplifier

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RF Characteristics (Pulsed CW)

| Freq (GHz) | P3dB (dBm) | Gain (dB) | Eff (%) | IRL (dB) |
|------------|------------|-----------|---------|----------|
| 1.805 | 48.25 | 29.06 | 30.31 | 14.6 |
| 1.8425 | 48.17 | 28.89 | 29.21 | 15.7 |
| 1.880 | 48.21 | 28.95 | 29.90 | 17.1 |
| 2.100 | 48.43 | 28.62 | 31.29 | 22.8 |
| 2.150 | 48.16 | 28.38 | 28.70 | 21.8 |
| 2.200 | 47.98 | 28.67 | 29.37 | 18.8 |

Test conditions unless otherwise noted: 25 °C, VDD = +28Vdc, $IDQ_Carrier = 100mA$, $IDQ_Peak = 17mA$, PW = 100us, DC = 10% test on WATECH Application Board

RF Characteristics (WCDMA)

| Freq (GHz) | Gain (dB) | Eff (%) | ACPR* @5MHz (dBc) | ACPR* @10MHz (dBc) |
|------------|-----------|---------|----------------------|-----------------------|
| 1.805 | 29.05 | 29.49 | -32.92 | -52.58 |
| 1.8425 | 28.84 | 29.36 | -33.22 | -51.83 |
| 1.880 | 28.78 | 30.45 | -33.15 | -51.03 |
| 2.100 | 28.43 | 30.52 | -36.18 | -50.03 |
| 2.150 | 28.33 | 28.76 | -37.55 | -50.47 |
| 2.200 | 28.54 | 29.75 | -36.86 | -50.82 |

Test conditions unless otherwise noted: 25 °C, VVDD = +28Vdc, IDQ_Carrier= 100mA, IDQ_Peak= 17mA, PAVG = 35 dBm 1C-WCDMA 5MHz Signal, 7.6 dB PAR @ 0.01% CCDF test on WATECH Application Board *Uncorrected DPD

Absolute Maximum Ratings

| Parameter | Range/Value | Unit |
|--|-------------|------|
| Drain voltage (VDSS) | -0.5 to +65 | V |
| Gate voltage (V _{GS}) | -5 to +10 | V |
| Drain voltage (VDD) | 0 to +28 | V |
| Storage Temperature (Tstg) | -55 to +150 | °C |
| Case Temperature (Tc) | -40 to +125 | °C |
| Junction Temperature (T _J) | -40 to +175 | °C |



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Electrical Specification

DC Characteristics

| Parameter | Conditions | Min | Тур | Max | Unit |
|---|-------------------|-----|-----|------|------|
| Breakdown Voltage V(BR)DSS [2] | Vgs=0V, Ids=100uA | 65 | - | - | V |
| Gate-Source Threshold Voltage VGS(th) [1] | Vgs=28V, Ids=17uA | 1.2 | - | 2.0 | V |
| Drain Leakage Current IDSS [2] | Vgs=0V, Vds=28V | - | - | 0.5 | uA |
| Gate Leakage Current IGSS [1] | Vgs=10V, Vds=0V | - | - | 0.05 | uA |

^[1] Including Driver and Final stage

RF Characteristics (Pulsed CW)

| Parameter | Freq (GHz) | Min | Тур. | Max | Unit |
|-----------|------------|------|------|-----|------|
| P3dB | 2.2 | 47.5 | 48.0 | - | dBm |

Test conditions unless otherwise noted: 25 °C, VDD = +28Vdc, $IDQ_Carrier = 100mA$, $IDQ_Peak = 17mA$, PW = 100us, DC = 10% test on WATECH Production Board

RF Characteristics (WCDMA)

| Parameter | Conditions | Min | Тур. | Max | Unit |
|------------|---------------|------|------|-----|------|
| Frequency | | GHz | | | |
| Gain | PAVG = 35 dBm | 26.5 | 28 | 32 | dB |
| Eff | PAVG = 35 dBm | 27 | 30 | 35 | % |
| ACPR@5MHz* | PAVG = 35 dBm | -40 | -36 | -28 | dBc |

Test conditions unless otherwise noted: 25 °C, VDD = +28Vdc, $IDQ_Carrier = 100mA$, $IDQ_Peak = 17mA$, 1C-WCDMA 20MHz Signal, 7.6 dB PAR @ 0.01% CCDF test on WATECH Production Board

Thermal Information

| Parameter | Condition | Value (Typ) | Unit |
|------------------------|-----------------------------------|-------------|-------|
| Thermal Resistance | TCASE= 90°C, 1C-WCDMA 5MHz | 2.5 | °C /W |
| Junction to Case (Rтн) | Signal, 7.6 dB PAR, PAVG = 35 dBm | | 0, |

^[2] Including Carrier and Peak

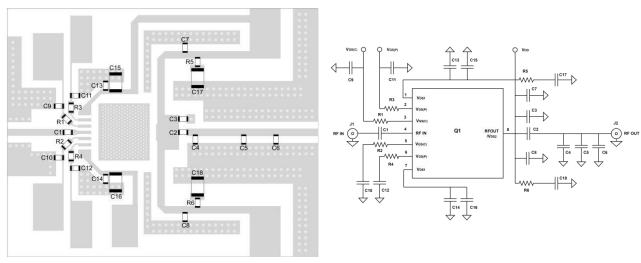
^{*}Uncorrected DPD



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H9G1822M60P 1.8 - 2.2 GHz Reference Design (50 x40 mm)

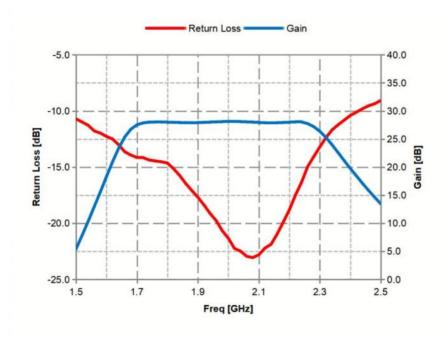


EVB Layout EVB Schematic

Bill of Materials (BoM) - H9G1822M60P 1.8 - 2.2 GHz Reference Design

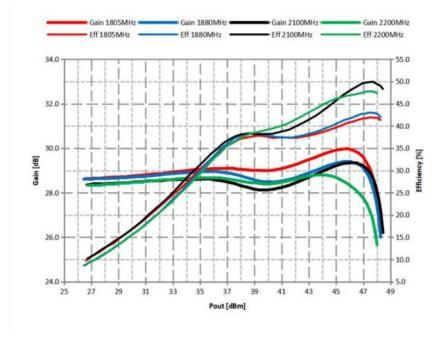
| Reference | Value | Description | Manufacturer | P/N | | |
|--|---|---|--------------|-------------------|--|--|
| Q1 | - | 60W, 1.8 - 2.2 GHz LDMOS MMIC PA | Watech | H9G1822M60P | | |
| C1, C4 | 2p7F | Multi-Layer Ceramic Capacitor | Murata | GQM2195C2E2R7BB12 | | |
| C2 | 2p4F | Multi-Layer Ceramic Capacitor | Murata | GQM2195C2E2R4BB12 | | |
| C3, C6 | 1p5F | Multi-Layer Ceramic Capacitor | Murata | GQM2195C2E1R5BB12 | | |
| C5 | 3pF | Multi-Layer Ceramic Capacitor | Murata | GQM2195C2E3R0BB12 | | |
| C7, C8 | 15pF | Multi-Layer Ceramic Capacitor | Murata | GQM2195C2E150GB12 | | |
| C9-C14 | 1nF | Multi-Layer Ceramic Capacitor | Murata | GRM21A5C2E102JWA1 | | |
| C15-C18 | 10uF | Multi-Layer Ceramic Capacitor Murata GRM32EC72A106KE0 | | | | |
| R1-R4 | 33Ω | Thick Film Resistor | YAGEO | RC0805FR-0733RL | | |
| R5, R6 | 10Ω Thick Film Resistor YAGEO RC0805FR-0710RL | | | | | |
| Rogers 4350B, er = 3.66; Thickness= 20 mil (0.508 mm); Thickness copper plating = 35 μm (1oz) Soldered on a 50x40x10 mm Copper Base-Plate | | | | | | |

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Small Signal, Gain and Return Loss vs Frequency

Test conditions unless otherwise noted: 25 °C, VDD = +28Vdc, $IDQ_Carrier = 100mA$, $IDQ_Peak = 17mA$ test on WATECH Application Board

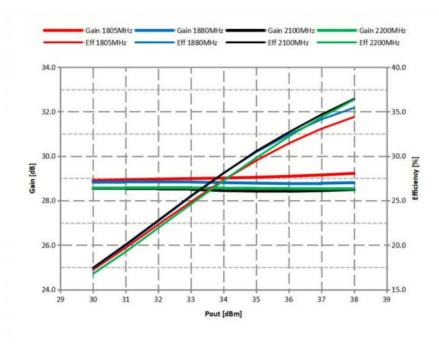


Pulsed CW, Gain and Efficiency vs Pout

Test conditions unless otherwise noted: $25 \, ^{\circ}$ C, VDD = +28Vdc, $IDQ_Carrier= 100mA$, $IDQ_Peak= 17mA$, PW = 100us, DC= 10% test on WATECH Application Board

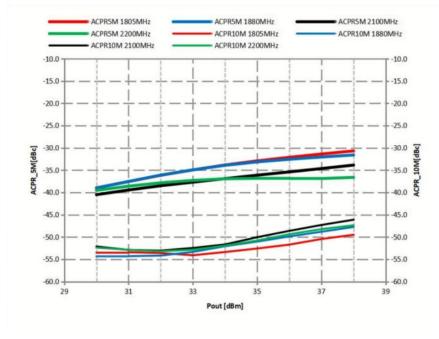


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WCDMA, Gain and Efficiency vs Pout

Test conditions unless otherwise noted: $25 \,^{\circ}$ C, VDD = +28Vdc, $IDQ_Carrier = 100mA$, $IDQ_Peak = 17mA$, 1C-WCDMA 5MHz Signal, 7.6 dB PAR @ 0.01% CCDF test on WATECH Application Board

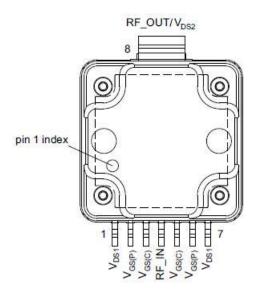


WCDMA, ACPR_5MHz, ACPR_10MHz vs Pout

Test conditions unless otherwise noted: 25 °C, VDD = +28Vdc, IDQ_Carrier= 100mA, IDQ_Peak= 17mA, 1C-WCDMA 5MHz Signal, 7.6 dB PAR @ 0.01% CCDF test on WATECH Application Board

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Pin Configuration and Description



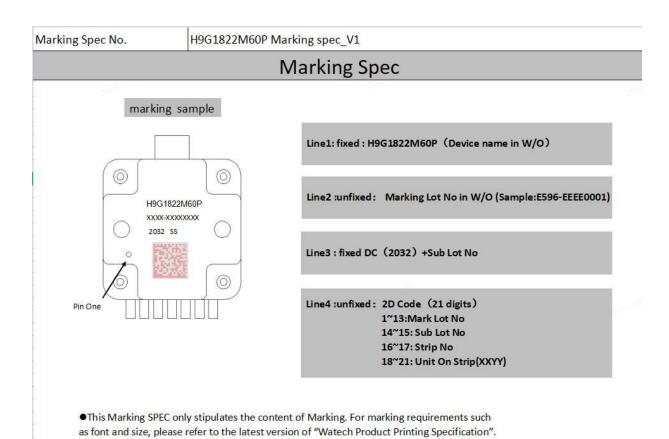
Pinout Device Configuration

| Pin Number | Label | Description |
|------------|-------------|--|
| 1 | VDS1 | Drain-Source Voltage Driver Stage |
| 2 | VGS(P) | Gate-Source Voltage Peak |
| 3 | VGS(C) | Gate-Source Voltage Main |
| 4 | RF IN | RF Input |
| 5 | VGS(C) | Gate-Source Voltage Main |
| 6 | VGS(P) | Gate-Source Voltage Peak |
| 7 | VDS1 | Drain-Source Voltage Driver Stage |
| 8 | RF OUT/VDS2 | RF Output & Drain-Source Voltage Final Stage |



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Package Marking and Dimensions

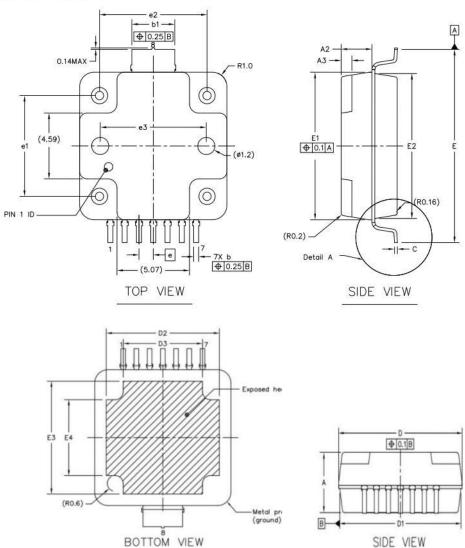


Marking



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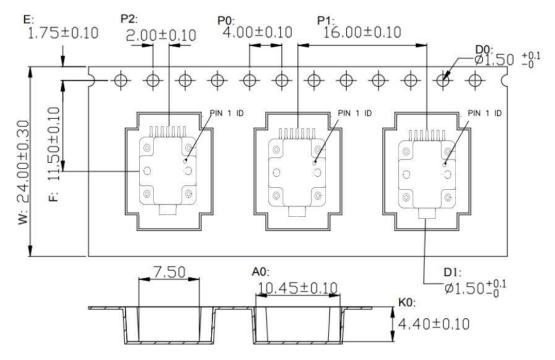
| SYMBOL | MIN | NOM | MAX |
|--------|----------|----------|-------|
| Α | 3.87 | 3.92 | 4 |
| A1 | -0.02 | 0 | 0.06 |
| A2 | | 2.15 REF | |
| A3 | | 0.75 REF | |
| A4 | | 1.57 REF | |
| ь | 0.3 | 0.35 | 0.4 |
| ь1 | 2.95 | 3 | 3.05 |
| D | 10.25 | 10.3 | 10.35 |
| D1 | 10.07 | 10.12 | 10.17 |
| D2 | 8.4 | 8.55 | 8.7 |
| D3 | 5.8 | 6 | 6.2 |
| E | 13.2 | 13.5 | 13.8 |
| E1 | 10.25 | 10.3 | 10.35 |
| E2 | 10.07 | 10.12 | 10.17 |
| E3 | 8.4 | 8.55 | 8.7 |
| E4 | 5.55 | 5.75 | 5.95 |
| e | | 1 BSC | |
| e1 | | 7.04 REF | |
| e2 | 7.52 REF | | |
| e3 | 7.42 REF | | |
| L | 0.8 | 0.95 | 1.1 |
| С | 0.17 | 0.22 | 0.27 |
| θ | 0. | 3. | 7. |

Package Dimensions

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Tape and Reel Information

| Package Type | Reel Size(inch) | Qty/Reel(pcs) | Qty/Box(pcs) | Qty/Carton(pcs) |
|--------------|-----------------|---------------|--------------|-----------------|
| OM400-8L | 13 | 600 | 600 | 3000 |



Tape & Reel Packaging Descriptions

Handling Precautions

| Parameter | Grade |
|--------------------------------|-------|
| Moisture Sensitivity Level MSL | 3 |

| Parameter | Rating | Standard |
|----------------------------------|-----------|-----------------|
| ESD – Human Body Model (HBM) | Class 1B | JESD22-A114 |
| ESD – Human Body Model (MM) | Class A | EIA/JESD22-A115 |
| ESD – Charged Device Model (CDM) | Class III | JESD22-C101 |





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RoHS Compliance

This product is compliant with the 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment), as amended by Directive 2015/863/EU.

Datasheet Status

| Document status | Product status | Definition |
|-----------------------|-------------------|--|
| Objective Datasheet | Design simulation | Product objective specification |
| Preliminary Datasheet | Customer sample | Engineering samples and first test results |
| Product Datasheet | Mass production | Final product specification |

Abbreviations

| Acronym | Definition | |
|---------|--|--|
| LDMOS | Laterally-Diffused Metal-Oxide Semiconductor | |
| CW | Continuous Waveform | |
| MMIC | Monolithic Microwave Integrated Circuit | |

Revision history

| Document ID | Datasheet Status | Release Date | Revision Version |
|-------------|------------------|--------------|-----------------------------|
| Rev 2.0 | Product | Nov 2022 | Product release |
| Rev 2.1 | Product | March 2023 | New format based on English |
| | Froduct | | version datasheet |



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For the latest specifications, additional product information, worldwide sales and distribution locations and information about WATECH:

• Web: www.watechelectronics.com

• Email: MKT@huatai-elec.com

For technical questions and application information:

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